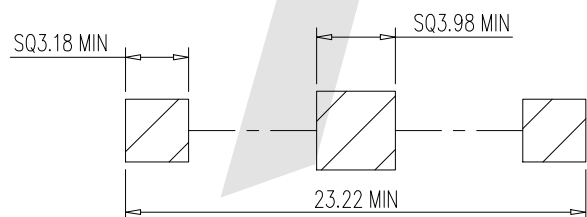
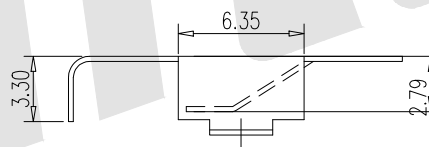
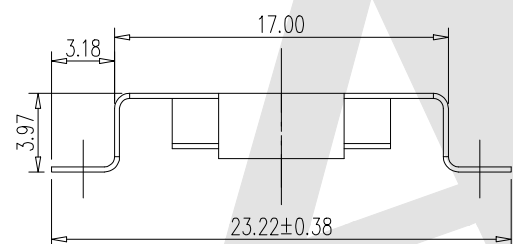
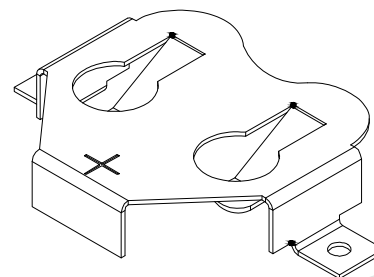
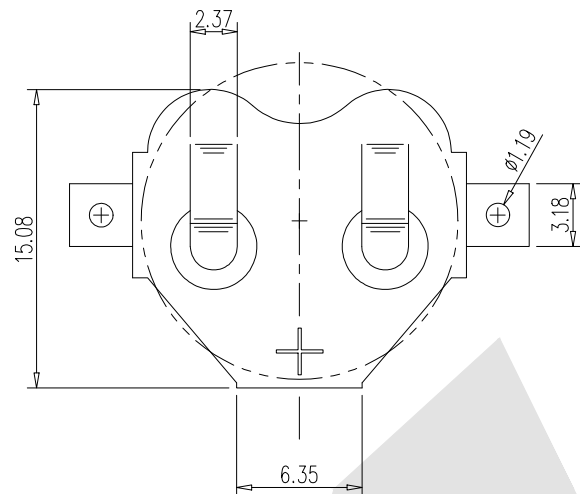


HSF



MOUNTING PAD LAYOUT

NOTES:

1.MATERIAL: PHOSPHOR BRONZE,T=0.25mm.

2.PLATING:

80U" Min TIN PLATED OVERALL

50U" Min NICKEL PLATED UNDER OVERALL

3.THIS PRODUCT IS SUITABLE FOR 24MM BATTERY

Order code:

BS - M - NI - R - 3012
① ② ③ ④ ⑤

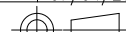
① BS: Battery Contacts

② Apperance for the product
M: SMT TYPE④ Packing method
R: Tape & reel packing
B: Bag packing⑤ Product number
3012: 3012 STYLE③ Contact Plating
NI: NICKEL PLATE
SN: Tin
G0: Gold flash
G1: 3u" Gold
G2: 5u" Gold
G3: 10u" Gold
G4: 15u" Gold
G5: 30u" Gold

Unless Otherwise specified tolerance
X.±0.35 X.XX: ±0.20
X.X: ±0.25 X.XXX: ±0.15

SCALE:
As ShownUNIT:
mmDRAW
ZLADATE
07/04/2023CHECK
BobYangDATE
07/04/2023

VER./版本号



3rd ANGLE PROJECTION



TITLE:

16mm SM COIN CELL CLIP

DRAWING NO: BS-M-NI-R-3012

PRODUCT NO: BS-M-NI-R-3012

MK/标记

DESCRIPTION/修订内容

DATE/日期(M/D/Y)